

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

LARRY ZHAO  
JEREMY MARTIN  
HARTMUT RUELKE

Examiner: Alexander G. Ghyka

Group Art Unit: 2812

Serial No.: 10/717,122

Att'y Docket: 2000.106900/DE0130

Filed: November 19, 2003

Customer No.: 23720

For: DIELECTRIC BARRIER LAYER FOR  
A COPPER METALLIZATION  
LAYER HAVING A VARYING  
SILICON CONCENTRATION ALONG  
ITS THICKNESS

**PRELIMINARY AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

CERTIFICATE OF MAILING

I hereby certify that this paper or fee is being deposited with the United States Postal Service with sufficient postage as "FIRST CLASS MAIL" addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, this 23<sup>rd</sup> day of May, 2005.

  
Signature

Prior to examination on the merits, please amend the claims as indicated herein.

It is believed that a fee in the amount of \$200 is due in connection with this Preliminary Amendment. **The Director is authorized to deduct such fee, and any other fees required under 37 C.F.R. §§ 1.16 to 1.21 for any reason relating to this document, from Advanced Micro Devices, Inc. Deposit Account No. 01-0365/DE0130.** In the event the monies in that account are insufficient, the Director is authorized to withdraw funds from Williams, Morgan & Amerson, P.C. Deposit Account No. 50-0786/2000.106900.